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Dated: August 26, 2010
Electronic Signature for James E. Armstrong, IV: /James E. Armstrong, IV/

Docket No.: 80444(302768)
(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:
Etsuo Okahara et al.

Application No.: 10/535,423

Confirmation No.: 6153

Filed: May 19, 2005

Art Unit: 1791

For: IN-MOLD COAT-FORMING METHOD AND
IN-MOLD-COATED MOLD PRODUCT

Examiner: E. H. Lee

AMENDMENT AFTER FINAL ACTION UNDER 37 C.F.R. 1.116

MS AF
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir/Madam:

INTRODUCTORY COMMENTS

In response to the Office Action dated July 13, 2010, finally rejecting claims 1, 8 and 16-23, please amend the above-identified U.S. patent application as follows:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks begin on page 5 of this paper.